

General Description

This product family offers state of the art performance. It is designed for high frequency applications where high efficiency and high reliability are required.

Features

- Low conduction loss due to low VF
- Extremely low switching loss by tiny Qc
- Highly rugged due to better surge current
- Industrial standard quality and reliability

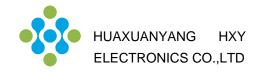
Applications

- UPS
- Power Inverter
- High performance SMPS
- Power factor correction

Ordering Part Number	Package	Qty(PCS)	
HSTPSC10H12BTR	TO-252-2L	2500	





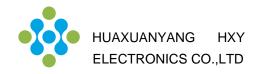


Maximum Ratings (at Tj = 25 °C, unless otherwise specified)

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	Vrrm	1200	V
Surge Peak Reverse Voltage	Vrsm	1200	V
DC Peak Reverse Voltage	Vr	1200	V
Continuous Forward Current Tc = 25°C Tc = 135°C Tc = 160°C	lF	30 15 10	A
Repetitive Peak Forward Surge Current $Tc = 25^{\circ}C, t_{p}=10ms, Half Sine Pulse$ $Tc = 110^{\circ}C, t_{p}=10ms, Half Sine Pulse$	Ifrm	57 41.5	A
Non-Repetitive Forward Surge Current $Tc = 25^{\circ}C, t_{p}=10ms, Half Sine Pulse$ $Tc = 110^{\circ}C, t_{p}=10ms, Half Sine Pulse$	IFSM	90 69.5	A
i ² dt value Tc = 25°C,t _P =10ms,Half Sine Pulse Tc = 110°C,t _P =10ms,Half Sine Pulse	∫ i²dt	40.5 24	A²s
Power dissipation Tc = 25°C Tc = 110°C	Ptot	115 50	W
Operating junction Range	Tj	-55 to +175	°C
Storage temperature Range	Tstg	-55 to +150	°C

Thermal Resistance

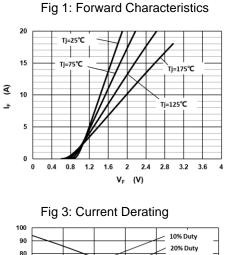
Parameter	Symbol	Value	Unit
Thermal resistance, junction – case.	RthJC	1.30	°C/W



Parameter	Symbol		Value		Unit	Test Condition	
	Oymbol	min.	typ.	max.	Onic		
						I⊧=2A	
Forward Voltage	VF	-	1.4	1.7	V	Tj=25°C	
		-	2.0	-		Tj=175°C	
						V _R =1200V	
Reverse Current	IR	-	-	100	μA	Tj=25°C	
		-	-	200		Tj=175°C	
						V ≈=800V,Tj=25 ℃	
Total Capacitive Charge	Qc	-	48	-	nC	$Q_{C} = \int_{0}^{V_{R}} C(V) dV$	
						Tj =25 ℃, f=1MHz	
		-	695	-	_	Vr=0V	
Total Capacitance	С	-	46	-	pF	VR=400V	
		-	35	-		Vr=800V	

Electrical Characteristic (at Tj = 25 °C, unless otherwise specified)

Characteristics Curve:



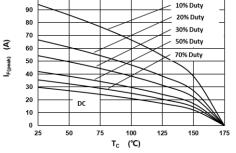
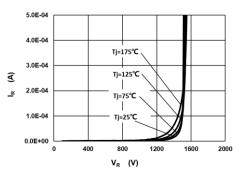
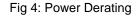
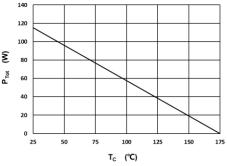


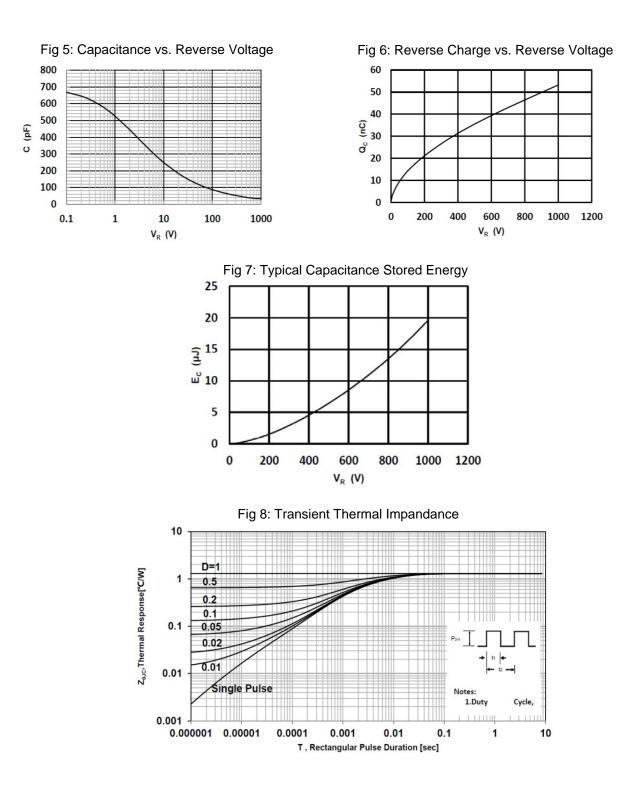
Fig 2: Reverse Characteristics

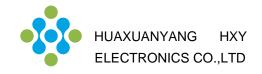






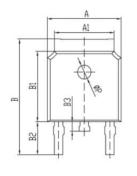


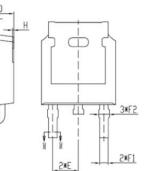




Package Dimensions

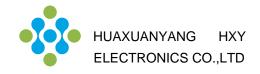
Package TO-252-2L





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项目	规范(mm)			
	MIN	MAX		
A	6.50	6.70		
A1	5.16	5.46		
В	9.77	10.17		
B1	6.00	6.20		
B2	2.60	3.00		
B3	0.70	0.90		
С	0.45	0.61		
D	2.20	2.40		
Е	2.186	2.386		
F1	0.67	0.87		
F2	0.76	0.96		
Н	0.00	0.30		
h	0.00	0.127		
L	6.50	6.70		
φP	1.10	1.30		



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